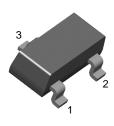
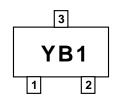


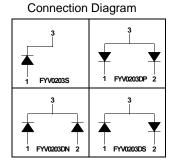
## FYV0203S/DN/DP/DS







**Marking**FYV0203S = YB1 FYV0203DP = YB3
FYV0203DN = YB2 FYV0203DS = YB4



## **Schottky Diode**

### Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	30	V
I <sub>F(AV)</sub>	Average Rectified Forward Current	0.2	А
I <sub>FSM</sub>	Non-repetitive Peak Surge Current Pulse Width = 1.0s	0.6	А
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>J</sub>	Operating Junction Temperature	150	°C

### **Thermal Characteristics**

Symbol Parameter		Value	Units
R <sub>0JA</sub> Thermal Resistance, Junction to Ambient		430	°C/W

### Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>F</sub> *	Forward Voltage Drop					mV
	I <sub>F</sub> = 0.1mA		-	210	240	
	I <sub>F</sub> = 1mA			270	320	
	I <sub>F</sub> = 10mA			340	400	
	I <sub>F</sub> = 30mA		-	390	500	
	I <sub>F</sub> = 100mA		-	485	800	
	I <sub>F</sub> = 200mA		-	600	1000	
I <sub>R</sub> *	Reverse Current					uA
	@ Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	-	0.2	2	
		T <sub>A</sub> = 125 °C	-	130	-	
Ст	Total Capacitance					pF
$V_R = 1V$ , $f = 1.0 \text{ MHz}$		-	-	10		
t <sub>rr</sub>	Reverse Recovery Time					ns
	$I_F = I_R = 10 \text{mA}, I_{RR} = 1 \text{mA}, R_L = 100 \Omega$		-	-	5	

<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

# **Typical Characteristics**

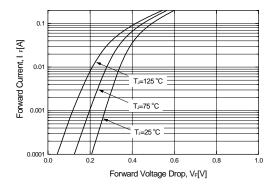


Figure 1. Typical Forward Voltage Characteristics



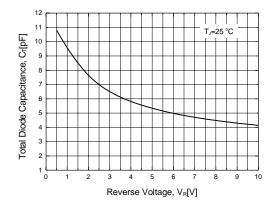
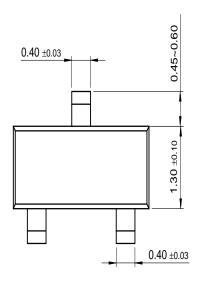


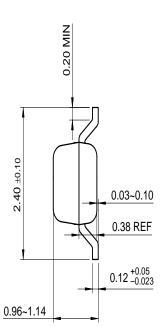
Figure 3. Total Diode Capacitance

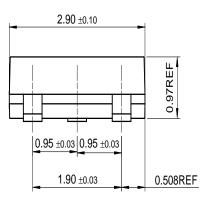
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# **Package Dimensions**

# SOT-23







Dimensions in Millimeters

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